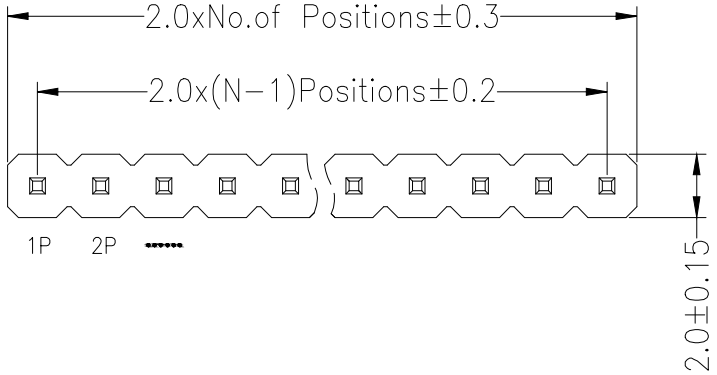
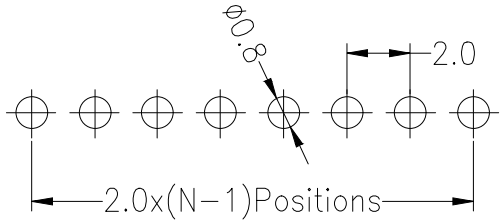
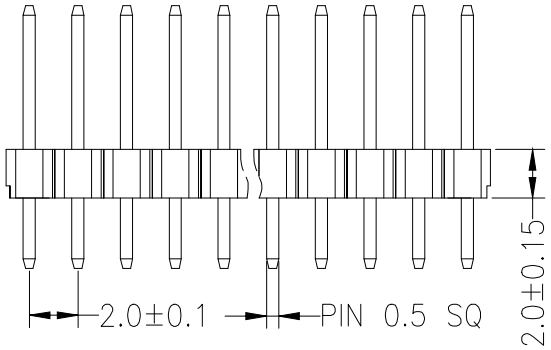


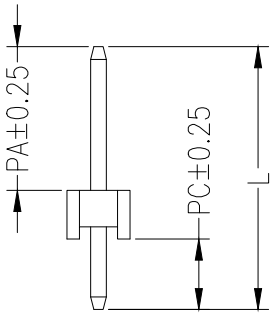
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 5 seconds)





Dimension antitheses list				
ITEM	PA	PB	PC	L
Standard	3.90	----	2.80	8.70
Alternate				

Ordering Information

XDZ 200 - * - N - Z - * - **

- No.of Rows: 1=Single Row, 2=Dual Row
- No.of Pins: 01-40 Pin
- Type: Z=直针, W=弯针, S=立贴, WS=卧贴
- Length: 塑高
- Contact Plating: G0:Gold Flash, G1:0.8u" Gold, G2:3u" Gold, G3:5u" Gold, G4:10u" Gold, G5:15u" Gold, G6:30u" Gold, S0:Gold Flash/Tin, S1:Tin

			GENERL TOLERANCE	制 图 DRAWING		深圳讯答科技有限公司 ShenzhenXundaTechnology Co.,Ltd			
			DIM TOL	审 核 CHECK					
			X.X ±0.30	批 准 APPROVAL		产品名称 TITLE	2.00 单排 直排针 (塑高2.0)	版本 REV.	A
1	初版发行		X.XX ±0.20	比 例 SCALE		产品料号 PART NO.	XDZ200-1-N-Z-2.0-G1	单位 UNITS	mm
序号 No.	变更内容 MODIFY CONTENT	日 期 MODIFY DATE	X.XXX ±0.10 Angle ±3.0°	投 影 Projection		材 料 MATERIAL		页 次 SHEET	1/1